Blackfin Processor Family











Why Choose a Blackfin Processor?

- High performance, 16-/32-bit Blackfin® processor core with DSP and RISC functionality and programmability
 - Eliminates need for multiple separate processors
- Large portfolio of products ranging from 300 MHz to 600 MHz
 - Best-in-class MHz/mW performance
- Best-in-class price performance
- Software controlled dynamic power management
- Extends battery life in portable applications
- Application-tuned system peripherals
 - · Provides glueless connectivity to a variety of external devices
- Many low cost pin- and code-compatible models
- Industrial temperature range allows for wide range of applications
- Supported by easy to use, world-class development tools
- · System-level integration with integrated flash and ADC on certain models
- Processors available with Lockbox® Secure Technology
- World-class ecosystem components and RTOS offerings from leading partners
- On-chip low power codec available on certain models



Blackfin Processors

Part Number	Package ¹	Speed (MHz)	RAM Me	mory (kB)	Ambient Temp Range (°C)	Key Peripherals	Price Range @ 1k (\$U.S.) ²	
ADSP-BF504BCPZ-4 ³	88-lead LFCSP	400	6	68	-40 to +85	SPI, PPI, SPORT, UART, PWM,		
ADSP-BF504KCPZ-4	88-lead LFCSP	400	,		0 to 70	ADC control module		
ADSP-BF504BCPZ-3F	88-lead LFCSP	300			-40 to +85			
ADSP-BF504KCPZ-3F	88-lead LFCSP	300			0 to 70	SPI, PPI, SPORT, UART, PWM, ADC control		
ADSP-BF504BCPZ-4F	88-lead LFCSP	400			-40 to +85	module, 4 MB parallel flash	Contact ADI	
ADSP-BF504KCPZ-4F	88-lead LFCSP	400	68	Flash	0 to 70		COIIIaCI ADI	
ADSP-BF506BSWZ-3F	120-lead LQFP_EP	300	00	memory 4 MB	-40 to +85			
ADSP-BF506KSWZ-3F	120-lead LQFP_EP	300			0 to 70	SPI, PPI, SPORT, UART, PWM, ADC control		
ADSP-BF506BSWZ-4F	120-lead LQFP_EP	400			-40 to +85	module, 4 MB parallel flash, 12-bit ADC		
ADSP-BF506KSWZ-4F	120-lead LQFP_EP	400			0 to 70			
ADSP-BF512BSWZ-3	176-lead LQFP_EP	300			-40 to +85			
ADSP-BF512BSWZ-4 ³	176-lead LQFP_EP	400			-40 to +85			
ADSP-BF512KBCZ-3	168-ball CSP_BGA	300		4.0	0 to 70	DDI ODI ODODT. TIM HADT		
ADSP-BF512KBCZ-4	168-ball CSP_BGA	400	1	16	0 to 70	PPI, SPI, SPORTs, TWI, UART		
ADSP-BF512KSWZ-3	176-lead LQFP_EP	300			0 to 70		6.26 to 9.92	
ADSP-BF512KSWZ-4	176-lead LQFP_EP	400			0 to 70			
ADSP-BF512BSWZ-4F4	176-lead LQFP_EP	400			-40 to +85			
ADSP-BF512KBCZ-4F4	168-ball CSP_BGA	400	116	Flash memory	0 to 70	PPI, SPI, SPORTS, TWI,		
ADSP-BF512KSWZ-4F4	176-lead LQFP_EP	400		512	0 to 70	UART, SPI flash		
ADSP-BF514BSWZ-3	176-lead LQFP_EP	300			-40 to +85			
ADSP-BF514BSWZ-4	176-lead LQFP_EP	400			-40 to +85			
ADSP-BF514KBCZ-3	168-ball CSP_BGA	300	116		0 to 70	PPI, SPI, SPORTS, TWI, UART,	7.77 to 10.50	
ADSP-BF514KBCZ-4	168-ball CSP_BGA	400			0 to 70	SDIO, CE-ATA, eMMC		
ADSP-BF514KSWZ-3	176-lead LQFP_EP	300			0 to 70			
ADSP-BF514KSWZ-4	176-lead LQFP_EP	400			0 to 70		1111 10 10100	
ADSP-BF514BSWZ-4F4	176-lead LQFP_EP	400			-40 to +85			
ADSP-BF514KBCZ-4F4	168-ball CSP_BGA	400	116	Flash memory	0 to 70	PPI, SPI, SPORTS, TWI, UART, SDIO,		
ADSP-BF514KSWZ-4F4	176-lead LQFP_EP	400		512	0 to 70	CE-ATA, eMMC, SPI flash		
ADSP-BF516BSWZ-3	176-lead LQFP_EP	300			-40 to +85			
ADSP-BF516BSWZ-4	176-lead LQFP_EP	400			-40 to +85			
ADSP-BF516KBCZ-3	168-ball CSP_BGA	300			0 to 70	PPI, SPI, SPORTs, TWI, UART,		
ADSP-BF516KBCZ-4	168-ball CSP_BGA	400	1	16	0 to 70	10/100 Ethernet, SDIO, CE-ATA, eMMC		
ADSP-BF516KSWZ-3	176-lead LQFP_EP	300			0 to 70		8.92 to 11.65	
ADSP-BF516KSWZ-4	176-lead LQFP_EP	400			0 to 70			
ADSP-BF516BSWZ-4F4	176-lead LQFP_EP	400			-40 to +85	DDL ODL ODODT THE HADT		
ADSP-BF516KBCZ-4F4	168-ball CSP_BGA	400	116	Flash memory	0 to 70	PPI, SPI, SPORTs, TWI, UART, 10/100 Ethernet, SDIO, CE-ATA,		
ADSP-BF516KSWZ-4F4	176-lead LQFP_EP	400		512	0 to 70	eMMC, SPI flash		
ADSP-BF518BSWZ-3	176-lead LQFP_EP	300			-40 to +85			
ADSP-BF518BSWZ-4 ³	176-lead LQFP_EP	400			-40 to +85			
ADSP-BF518KBCZ-3	168-ball CSP_BGA	300			0 to 70	PPI, SPI, SPORTS, TWI, UART,		
ADSP-BF518KBCZ-4	168-ball CSP_BGA	400	1	16	0 to 70	10/100 Ethernet with 1588, SDIO, CE-ATA, eMMC		
ADSP-BF518KSWZ-3	176-lead LQFP_EP	300			0 to 70	OL-AIA, GIVIIVIO	13.07 to 14.07	
ADSP-BF518KSWZ-4	176-lead LQFP_EP	400			0 to 70			
ADSP-BF518BSWZ-4F4	176-lead LQFP_EP	400			-40 to +85	DDI ODI 2222 - 7/2		
ADSP-BF518KBCZ-4F4	168-ball CSP_BGA	400	116	Flash memory	0 to 70	PPI, SPI, SPORTs, TWI, UART, 10/100 Ethernet with 1588, SDIO,		
						CE-ATA, eMMC, SPI flash		

Packages: LQFP_EP (low profile quad flat pack exposed pad); CSP_BGA (chip scale package ball grid array); PBGA (plastic ball grid array); LFCSP (lead frame chip scale package).

²All pricing is budgetary and subject to change.

³Available in automotive grade.

Blackfin Processors (continued)

Part Number	Package ¹	Speed (MHz)	RAM Memory (kB)	Ambient Temp Range (°C)	Key Peripherals	Price Range @ 1k (\$U.S.) ²
ADSP-BF522KBCZ-3	289-ball CSP_BGA			0 to 70		
ADSP-BF522BBCZ-3A	208-ball CSP_BGA	300		-40 to +⊠85		
ADSP-BF522KBCZ-3C2	289-ball CSP_BGA			0 to 70		Contact ADI
ADSP-BF522KBCZ-4	289-ball CSP_BGA			0 to 70		COIIIaCLADI
ADSP-BF522BBCZ-4A	208-ball CSP_BGA	400		-40 to +85		
ADSP-BF522KBCZ-4C2	289-ball CSP_BGA		132	0 to 70	PPI, SPI, SPORTs, NAND interface,	
ADSP-BF523KBCZ-5	289-ball CSP_BGA		132	0 to 70	TWI, host DMA, UART, Lockbox	
ADSP-BF523BBCZ-5A	208-ball CSP_BGA	533		-40 to +85		
ADSP-BF523KBCZ-5C2	289-ball CSP_BGA					10.40 to 10.0
ADSP-BF523KBCZ-6	289-ball CSP_BGA			0.4. 70		13.46 to 19.2
ADSP-BF523KBCZ-6A	208-ball CSP_BGA	600		0 to 70		
ADSP-BF523KBCZ-6C2	289-ball CSP_BGA					
ADSP-BF524KBCZ-3	289-ball CSP_BGA			0 to 70		
ADSP-BF524BBCZ-3A	208-ball CSP_BGA	300		-40 to +85		
ADSP-BF524KBCZ-3C2	289-ball CSP_BGA			0 to 70		Contact ADI
ADSP-BF524KBCZ-4	289-ball CSP_BGA			0 to 70		OUTILOU ADI
ADSP-BF524BBCZ-4A	208-ball CSP_BGA	400		-40 to +85		
ADSP-BF524KBCZ-4C2	289-ball CSP_BGA		100	0 to 70	PPI, SPI, SPORTs, NAND interface, TWI, host DMA, UART, Lockbox,	
ADSP-BF525KBCZ-5	289-ball CSP_BGA	132		0 to 70	HS USB OTG	
ADSP-BF525BBCZ-5A3	208-ball CSP_BGA	533		-40 to +85		
ADSP-BF525KBCZ-5C2	289-ball CSP_BGA					15 17 to 01 0
ADSP-BF525KBCZ-6	289-ball CSP_BGA			0.4. 70		15.17 to 21.0
ADSP-BF525KBCZ-6A	208-ball CSP_BGA	600		0 to 70		
ADSP-BF525KBCZ-6C2	289-ball CSP_BGA					
ADSP-BF526KBCZ-3	289-ball CSP_BGA			0 to 70		
ADSP-BF526BBCZ-3A	208-ball CSP_BGA	300		-40 to +85		
ADSP-BF526KBCZ-3C2	289-ball CSP_BGA			0 to 70		Ott ADI
ADSP-BF526KBCZ-4	289-ball CSP_BGA			0 to 70		Contact ADI
ADSP-BF526BBCZ-4A	208-ball CSP_BGA	400		-40 to +85		
ADSP-BF526KBCZ-4C2	289-ball CSP_BGA		100	0 to 70	PPI, SPI, SPORTs, 10/100 Ethernet,	
ADSP-BF527KBCZ-5	289-ball CSP_BGA		132	0 to 70	TWI, host DMA, NAND interface, UART, Lockbox, HS USB OTG	
ADSP-BF527BBCZ-5A	208-ball CSP_BGA	533		-40 to +85		
ADSP-BF527KBCZ-5C2	289-ball CSP_BGA					10.00 to 00.0
ADSP-BF527KBCZ-6	289-ball CSP_BGA]	0.4. 70		16.99 to 22.8
ADSP-BF527KBCZ-6A	208-ball CSP_BGA	600		0 to 70		
ADSP-BF527KBCZ-6C2	289-ball CSP_BGA					

^{&#}x27;Packages: LQFP_EP (low profile quad flat pack exposed pad); CSP_BGA (chip scale package ball grid array); PBGA (plastic ball grid array); LFCSP (lead frame chip scale package).

 $^{^{\}rm 2}\text{All}$ pricing is budgetary and subject to change.

³Available in automotive grade.

Blackfin Processors (continued)

Part Number	Package ¹	Speed (MHz)	RAM Memory (kB)	Ambient Temp Range (°C)	Key Peripherals	Price Range @ 1k (\$U.S.) ²
ADSP-BF531SBB400	169-ball PBGA					
ADSP-BF531SBBC400	160-ball CSP_BGA					
ADSP-BF531SBBCZ400 ³	160-ball CSP_BGA	400	52	-40 to +85		5.70 to 12.81
ADSP-BF531SBBZ400 ³	169-ball PBGA					
ADSP-BF531SBSTZ4003	176-lead LQFP				PPI, UART, SPI, 2 SPORTs,	
ADSP-BF532SBBC400	160-ball CSP_BGA				3 timers, 16 GPIOs	
ADSP-BF532SBBCZ400 ³	160-ball CSP_BGA					
ADSP-BF532SBSTZ400 ³	176-lead LQFP	400	84	-40 to +85		9.33 to 17.31
ADSP-BF532SBB400	169-ball PBGA					
ADSP-BF532SBBZ400	169-ball PBGA					
ADSP-BF533SBBC400	160-ball CSP_BGA	400				
ADSP-BF533SBBCZ400	160-ball CSP_BGA	400				
ADSP-BF533SBBZ400	169-ball PBGA	400				
ADSP-BF533SBSTZ400	176-lead LQFP	400				
ADSP-BF533SBBC500	160-ball CSP_BGA	500				
ADSP-BF533SBBCZ500 ³	160-ball CSP_BGA	500		-40 to +85		12.19 to 22.21
ADSP-BF533SBB500	160-ball CSP_BGA	500	148		PPI, UART, SPI, 2 SPORTs, 3 timers, 16 GPIOs	
ADSP-BF533SBBZ500 ³	169-ball PBGA	500			o amoro, ro arroo	
ADSP-BF533SBBC-5V	160-ball CSP_BGA	533				
ADSP-BF533SBBCZ-5V	160-ball CSP_BGA	533				
ADSP-BF533SKBC-6V	160-ball CSP_BGA	600		0.1.70		
ADSP-BF533SKBCZ-6V	160-ball CSP_BGA	600		0 to 70		
ADSP-BF534BBC-4A	182-ball CSP_BGA	400				
ADSP-BF534BBCZ-4A3	182-ball CSP_BGA	400				
ADSP-BF534BBCZ-4B ³	208-ball CSP_BGA	400				
ADSP-BF534BBC-5A	182-ball CSP_BGA	500	132	-40 to +85	CAN®, PPI/SPI, TWI, 8 timers, 48 GPIOs, 2 SPORTs/UARTs	12.40 to 18.53
ADSP-BF534BBCZ-5A	182-ball CSP_BGA	500			40 di 103, 2 di 01113/0/1113	
ADSP-BF534BBCZ-5B	208-ball CSP_BGA	500				
ADSP-BF534YBCZ-4B ³	208-ball CSP_BGA	400		-40 to +105		
ADSP-BF535PBB-200	260-ball PBGA	200		-40 to +85		
ADSP-BF535PBBZ-200	260-ball PBGA	200		-40 to +85		
ADSP-BF535PKB-300	260-ball PBGA	300		0 to 70		
ADSP-BF535PKBZ-300	260-ball PBGA	300	308	0 to 70	2 SPIs, 2 SPORTs, USB device, PCI	30.36 to 45.92
ADSP-BF535PBB-300	260-ball PBGA	300		-40 to +85		
ADSP-BF535PKB-350	260-ball PBGA	350		0 to 70		
ADSP-BF535PKBZ-350	260-ball PBGA	350		0 to 70		
ADSP-BF536BBC-3A	182-ball CSP_BGA	300				
ADSP-BF536BBCZ-3A	182-ball CSP_BGA	300				
ADSP-BF536BBCZ-3B	208-ball CSP_BGA	300			10/100 Ethernet, CAN, PPI, TWI, 8 timers,	
ADSP-BF536BBC-4A	182-ball CSP_BGA	400	100	-40 to +85	48 GPIOs, 2 SPORTs/UARTs, SPI	10.07 to 14.42
ADSP-BF536BBCZ-4A	182-ball CSP_BGA	400				
ADSP-BF536BBCZ-4B	208-ball CSP_BGA	400				

'Packages: LQFP_EP (low profile quad flat pack exposed pad); CSP_BGA (chip scale package ball grid array); PBGA (plastic ball grid array); LFCSP (lead frame chip scale package).

²All pricing is budgetary and subject to change.

³Available in automotive grade.

Blackfin Processors (continued)

Part Number	Package ¹	Speed (MHz)	RAM Memory (kB)	Ambient Temp Range (°C)	Key Peripherals	Price Range @ 1k (\$U.S.) ²
ADSP-BF537BBC-5A	182-ball CSP_BGA	500				
ADSP-BF537BBCZ-5A	182-ball CSP_BGA	500				
ADSP-BF537BBCZ-5B	208-ball CSP_BGA	500		-40 to +85 -40 to +85 -40 to +85 0 to 70 -40 to +85 -40 to 70 0 to 70 0 to 70 0 to 70 0 to 70 -40 to +85 0 to 70		
ADSP-BF537BBCZ-5AV	182-ball CSP_BGA	533	132		10/100 Ethernet, CAN, PPI, TWI, 8 timers, 48 GPIOs, 2 SPORTs/UARTs, SPI	17.15 to 21.20
ADSP-BF537BBCZ-5BV	208-ball CSP_BGA	533			10 at 100, 2 of 01110, 011110, 011	
ADSP-BF537KBCZ-6AV	182-ball CSP_BGA	600		0 to 70		
ADSP-BF537KBCZ-6BV	208-ball CSP_BGA	600		0 to 70		
ADSP-BF538BBCZ-4A	316-ball CSP_BGA	400				
ADSP-BF538BBCZ-4F8	316-ball CSP_BGA	400			CAN 2.0B, 54 GPIOs, 4 SPORTs,	40.00 to 00.07
ADSP-BF538BBCZ-5A	316-ball CSP_BGA	533	440		3 UARTs, 3 SPIs, 2 TWIs, PPI, 8 MB flash	16.03 to 20.67
ADSP-BF538BBCZ-5F8	316-ball CSP_BGA	533	148	-40 to +85		
ADSP-BF539BBCZ-5A3	316-ball CSP_BGA	533	-		MXVR, CAN, 54 GPIOs, 4 SPORTs,	Ott ADI
ADSP-BF539BBCZ-5F83	316-ball CSP_BGA	533			3 UARTs, 3 SPIs, 2 TWIs, PPI, 8 MB flash	Contact ADI
ADSP-BF542BBCZ-5A ³	400-ball CSP_BGA	533		-40 to +85		
ADSP-BF542KBCZ-6A	400-ball CSP_BGA	600	132	0 to 70	CAN, ⁴ HS USB OTG, 3 EPPIs, pixel comp, ATAPI-6, Lockbox	
ADSP-BF542MBBCZ-5M⁵	400-ball CSP_BGA	533		-40 to +85	pixer comp, AIAI 1-0, Lockbox	
ADSP-BF544BBCZ-5A ³	400-ball CSP_BGA	533	196		CAN,4 Host DMA, 3 EPPIs,	
ADSP-BF544MBBCZ-5M ⁵	400-ball CSP_BGA	533	132	-40 to +85	pixel comp, Lockbox	
ADSP-BF547BBCZ-5A	400-ball CSP_BGA	533	260	-40 to +85		45.00.00.40
ADSP-BF547KBCZ-6A	400-ball CSP_BGA	600	260	0 to 70	HS USB OTC, 3 EPPIs, pixel comp, ATAPI-6, Lockbox	15.66 to 22.12
ADSP-BF547MBBCZ-5M⁵	400-ball CSP_BGA	533	132	-40 to +85	AIAI I O, LOOKDOX	
ADSP-BF548BBCZ-5A	400-ball CSP_BGA	533	260		HS USB OTG, 3 EPPIs, pixel comp,	•
ADSP-BF548MBBCZ-5M ⁵	400-ball CSP_BGA	533	132		ATAPI-6, Lockbox, CAN	
ADBF549WBBCZ502 ^{3, 5}	400-ball CSP_BGA	533	260	-40 to +85	MXVR, CAN, HS USB OTG, ATAPI-6,	
ADBF549MWBBCZ503 ³	400-ball CSP_BGA	533	132		3 EPPIs, pixel comp, Lockbox	
ADSP-BF561SKB500	297-ball PBGA	500		0 to 70		
ADSP-BF561SKBZ500	297-ball PBGA	500		0 to 70		
ADSP-BF561SKBCZ-5A	256-ball CSP_BGA	500		0 to 70		
ADSP-BF561SKBCZ-5V	256-ball CSP_BGA	533		0 to 70		
ADSP-BF561SBB500	297-ball PBGA	500		-40 to +85		
ADSP-BF561SBBZ500 ³	297-ball PBGA	500		-40 to +85		
ADSP-BF561SBBCZ-5A3	256-ball CSP_BGA	500		-40 to +85		
ADSP-BF561SKB600	297-ball PBGA	600	328	0 to 70	2 PPIs, UART, 12 timers, 2 SPORTs	20.40 to 35.74
ADSP-BF561SKBZ600	297-ball PBGA	600		0 to 70		
ADSP-BF561SKBCZ500	256-ball CSP_BGA	500		-40 to +85		
ADSP-BF561SKBCZ-6A	256-ball CSP_BGA	600		0 to 70		
ADSP-BF561SKBCZ-6V	256-ball CSP_BGA	600		0 to 70		
ADSP-BF561SBB600	297-ball PBGA	600		-40 to +85		
ADSP-BF561SBBZ600	297-ball PBGA	600		-40 to +85		

Packages: LQFP_EP (low profile quad flat pack exposed pad); CSP_BGA (chip scale package ball grid array); PBGA (plastic ball grid array); LFCSP (lead frame chip scale package).

 $^{^{2}\}mbox{All}$ pricing is budgetary and subject to change.

³Available in automotive grade.

⁴Available on automotive-grade parts only.

 $^{^{\}rm 5}\text{M}$ designates support for 1.8 V mobile DDR memory.

Development Tools

The Blackfin processor is supported by the Analog Devices CROSSCORE® line of robust and flexible development tools.

VisualDSP++ Software

VisualDSP++® software delivers efficient project management, enabling programmers to move easily between editing, building, and debugging within a single interface. Key features include an optimizing C/C++ compiler, advanced plotting tools, embedded OS support (VDK), award-winning statistical profiling, TCP/IP and USB support, free software upgrades, and technical support.

EZ-Board Evaluation Boards

The EZ-Board $^{\text{TM}}$ evaluation board provides developers with a low cost platform for initial evaluation of the processors via an external emulator or μ .Clinux. $^{\text{TM}}$ The EZ-Board evaluation board has an expansion interface that allows for modularity with different EZ-Extender boards.

EZ-KIT Lite Evaluation Kit

The EZ-KIT Lite® evaluation kit is a standalone evaluation board and evaluation suite of VisualDSP++ software to facilitate architecture evaluation.

EZ-Extender Daughter Boards

EZ-Extender® daughter boards enable developers to access and connect various peripherals from Analog Devices and third parties to the expansion interface of the EZ-KIT Lite evaluation kits.

Emulators

Analog Devices cost-effective and high performance emulators provide an easy, portable, nonintrusive, target-based debugging solution for Analog Devices JTAG processors and DSPs.

These powerful emulators perform a wide range of emulation functions, including single-step and full-speed execution with predefined breakpoints, and viewing and/or altering of register and memory contents.

Debug Agent Board

The Standalone Debug Agent is intended to provide a modular low cost emulation solution for EZ-Board evaluation boards as well as evaluation boards designed by third parties. The Standalone Debug Agent is very similar to the Debug Agent that is on existing EZ-KIT Lite evaluation boards but will have the flexibility to move from one board to another.

Software Modules

Analog Devices has a wide range of tested and optimized software modules available, including decoders, encoders, codecs, and other algorithms that provide multimedia functions for the Blackfin and SHARC processor families. The software modules allow engineers to quickly and easily incorporate these functions, providing a faster development path to the end product. In addition, the highly optimized software modules feature a consistent API and framework to ensure rapid development of multiple functions. Visit www.analog.com/software for more information.

Platforms and Reference Designs

Platforms and reference designs help jump-start your design. They include comprehensive software suites with documented APIs running on application-specific evaluation boards. The easy to use APIs enable customization and control of core system functions, letting you focus on adding value through product differentiation. For more information on Analog Devices platforms, reference designs, and third-party reference designs, visit www.analog.com/referencedesigns,

Extended Development Tools and Support

Starter Kits

Analog Devices starter kits provide everything you need to get started on an application. Kits contain a Blackfin EZ-KIT Lite, EZ-Extender daughter board(s), and the software development kit (SDK), which contains sample code, "how to" documents, and various encoders/decoders that make getting started on an application easy and shorten the learning curve.

Software Development Kits

The SDK contains example software, source code, device drivers, algorithms, utilities information, and application notes that allow you to develop processor applications. The software can be used as a framework, or as examples of how to use certain aspects and peripherals, in conjunction with an ADI processor. The SDK is included in the starter kits and is also downloadable for free, provided you have the required hardware, at www.analog.com/sdk/downloads.

μClinux

The μ Clinux kernel and GNU toolchain are available for the Blackfin processor and can be downloaded from the μ Clinux for Blackfin processor website (*www.blackfin.uclinux.org*), which is the central repository for all Blackfin processor open-source projects. One of the board support packages available is the ADSP-BF537 STAMP μ Clinux kernel board support package (BSP). The BSP is composed of the ADSP-BF537 STAMP development board (including the full complement of memory along with serial and network interfaces), a recent copy of the open-source development tools, μ Clinux kernel, and bootloader. The STAMP board is specifically designed to support the development and porting of open-source μ Clinux applications.

NI LabVIEW Embedded Module for ADI Blackfin Processors

The NI LabVIEW™ Embedded Module for ADI Blackfin processors is a comprehensive graphical development environment for embedded design. This module builds on NI LabVIEW embedded technology, which facilitates dataflow graphical programming for embedded systems and includes hundreds of analysis and signal processing functions, integrated I/O, and an interactive debugging interface. With the NI LabVIEW Embedded Module for ADI Blackfin processors, users can easily access essential VisualDSP++ specific compiler options through LabVIEW, such as the ability to enable cache, optimize linking, and view live front-panel updates via JTAG. To help debug those challenging designs, users can connect the host development PC evaluation hardware or end product using an ADI JTAG emulator. LabVIEW includes a wide array of built-in visualization features including tools for charting and graphing real-time data, and reconfiguring attributes of data presentation, such as colors, font size, and graph types. Furthermore, users can dynamically tune applications at run time through live front panel controls.

Blackfin Processor Development Tools

Blackfin Processor	Hardware		Emulator	VisualDSP++ Development Software	Additional Software Available
ADSP-BF504 ADSP-BF504F ADSP-BF506F	ADZS-BF506F-EZLITE Key Features • ADSP-BF506F Blackfin processor with integrated 12-bit ADC and 4 MB stacked flash • 12-bit ADC input connectors • UART interface/DB9 connector • SDIO interface • Expansion interface • Standalone debug agent interface				
ADSP-BF512 ADSP-BF512F ADSP-BF514 ADSP-BF514F ADSP-BF516 ADSP-BF516F ADSP-BF518 ADSP-BF518F	ADZS-BF518F-EZBRD Key Features • ADSP-BF518F Blackfin processor • SDRAM • Flash • SPI flash • Audio codec • Power analysis interface • Ethernet PHY • Analog-to-digital converter • Thumbwheel • UART • RTC battery	ADZS-BF518F-EZLITE ADZS-BFLLCD-EZEXT ADZS-DBGAGENT-BRD ADZS-BLUET-EZEXT ADZS-BFSHUSB-EZEXT			
ADSP-BF522 ADSP-BF522C ADSP-BF524 ADSP-BF524C ADSP-BF526 ADSP-BF526	ADZS-BF526-EZBRD Key Features • ADSP-BF526 Blackfin processor • SDRAM • Flash: 4 MB (2M × 16) • NAND flash: 2 Gb • SPI flash • Audio codec • Power analysis interface • Ethernet PHY • Battery or USB bus powered	ADZS-BF526-EZLITE ADZS-DBGAGENT-BRD ADZS-BFLLCD-EZEXT ADZS-BLUET-EZEXT ADZS-BFSHUSB-EZEXT	ADZS-ICE-100B ADZS-USB-ICE ADZS-HPUSB-ICE	VDSP-BKFN-PC-TEST VDSP-BLKFN-PC-FULL VDSP-BLKFN-PCFLOAT VDSP-BLKFN-PCFLT-5	VDSP-LABVIEW-EMB (All parts except ADSP-BF535 and ADSP-BF0x family) VDSP-LABVIEW-EVAL (All parts except ADSP-BF535 and ADSP-BF0x family)
ADSP-BF523 ADSP-BF523C ADSP-BF525 ADSP-BF525C ADSP-BF527C ADSP-BF527C	ADZS-BF527-EZLITE Key Features ADSP-BF527 Blackfin processor SDRAM NAND flash: 4 Gb Audio codec HS USB OTG Ethernet PHY LCD display Touch screen/keyboard controller	ADZS-BF527-MPSKIT ADZS-BFAV-EZEXT ADZS-BFFPGA-EZEXT			Mathworks" (ADSP-BF531/ADSP-BF532/ ADSP-BF533/ADSP-BF534/ ADSP-BF536/ADSP-BF537/ ADSP-BF538/ADSP-BF539 only) µClinux—open source (All parts except ADSP-BF535 and ADSP-50x family) GNU toolchain (Not available for the ADSP-BF535)
ADSP-BF531 ADSP-BF532 ADSP-BF533	ADZS-BF533-EZLITE Key Features ADSP-BF533 Blackfin processor 64 MB (32M × 16-bit) SDRAM 2 MB (512k × 16-bit × 2) Flash memory AD1836 96 kHz audio codec with 4 input and 6 output RCA jacks ADV7183 video decoder with 3 input RCA jacks • ADV7171 video encoder with 3 output RCA jacks • ADM3202 RS-232 line driver/ receiver	ADZS-BF-EZEXT-1 ADZS-BFAV-EZEXT ADZS-USBLAN-EZEXT ADZS-BFAUDIO-EZEXT ADZS-BFFPGA-EZEXT ADZS-BF533-MMSKIT			

Blackfin Processor Development Tools (continued)

Blackfin Processor	Hardware		Emulator	VisualDSP++ Development Software	Additional Software Available
ADSP-BF534 ADSP-BF536 ADSP-BF537	ADZS-BF537-EZLITE Key Features • ADSP-BF537 Blackfin processor • Max core clock rate of 600 MHz • 64 MB (32M × 16) SDRAM, 4 MB (2M × 16) flash memory • SMSC LAN83C185 10/100 PHY with BJ45 connector • CAN TJA1041 transceiver with 2 RJ10 connectors • AD1871 96 kHz stereo ADC with 1/8" jack connector • AD1854 96 kHz stereo DAC with 1/8" jack connector • RS-232 UART line driver/receiver • National Instruments Educational Laboratory Virtual Instrumentation Suite (NI ELVIS) interface	ADZS-BLUET-EZEXT ADZS-BFAV-EZEXT ADZS-BFLLCD-EZEXT ADZS-USBLAN-EZEXT ADZS-BFAUDIO-EZEXT ADZS-BFF9GA-EZEXT ADZS-BF537-ASKIT Additional Hardware • ADSP-BF537-STAMP • PHYTEC Phycore®			
ADSP-BF538 ADSP-BF538F	ADZS-BF538F-EZLITE Key Features • ADSP-BF538F Blackfin processor • 64 MB (32M × 16) SDRAM • 4 MB (2M × 16) flash memory • ADM3202 RS-232 line driver/receiver • AD1871 96 kHz stereo ADC • AD1854 96 kHz stereo DAC • TJA1041 transceiver • 2 RJ10 connectors • 9 LEDs	ADZS-BFLLCD-EZEXT	4070 (05.400)	VDSP-BKFN-PC-TEST	VDSP-LABVIEW-EMB (All parts except ADSP-BF35 and ADSP-BF0x family) VDSP-LABVIEW-EVAL (All parts except ADSP-BF35 and ADSP-BF0x family) Mathworks
ADSP-BF542 ADSP-BF544 ADSP-BF547 ADSP-BF548 ADSP-BF549	ADZS-BF548-EZLITE Key Features ADSP-BF548 Blackfin processor DDR SDRAM BURST flash NAND flash Hard drive LCD display AC'97 codec Ethernet PHY Touch screen/keyboard controller	ADZS-BLUET-EZEXT ADZS-BFAV-EZEXT ADZS-BFFPGA-EZEXT ADZS-BFLLCD-EZEXT ADZS-BF548-MPSKIT	- ADZS-ICE-100B ADZS-USB-ICE ADZS-HPUSB-ICE	VDSP-BLKFN-PC-FULL VDSP-BLKFN-PCFLOAT VDSP-BLKFN-PCFLT-5	(ADSP-BF531/ADSP-BF532/ ADSP-BF533/ADSP-BF534/ ADSP-BF536/ADSP-BF539 only) µClinux—open source (All parts except ADSP-BF535 and ADSP-50x family) GNU toolchain (Not available for the ADSP-BF535)
ADSP-BF561	ADZS-BF561-EZLITE Key Features • ADSP-BF561 Blackfin processor • 64 MB (16M × 16-bit × 2) SDRAM • 8 MB (4M × 16-bit) flash memory • AD1836 multichannel 96 kHz audio codec • RCA jacks for stereo audio input/output • ADV7183A advanced 10-bit video decoder • 3 RCA jacks for composite (CVBS), differential component (YUV), or S-Video (Y/C) input • ADV7179 chip scale NTSC/PAL video encoder • 3 RCA jacks for composite (CVBS), component (RGB), differential component (RGB), differential component (YUV), or S-Video (Y/C) output	ADZS-BF561-MMSKIT			

Blackfin Processor Product Portfolio

Value

Highest Performance

	BLACK FEET	ADSP-BF504F ADSP-BF506F	ADSP-BF512		ADSP-BF522 ADSP-BF524 ADSP-BF526	ADSP-BF525	ADSP-BF531 ADSP-BF532	Buck Buck Buck Buck Buck Buck Buck Buck	ADSP-BF535 ADSP-BF536	ADSP-BF537	ADSP-BF538 ADSP-BF539	ADSP-BF542 ADSP-BF544 ADSP-BF547 ADSP-BF548 ADSP-BF549	BLOOK ADSP-BF561	BLACK FEEL
Low BOM Cost	•	•	•		•	•	•							
Baseline Connectivity	•	•	•		•	•	•	•					•	
System-Level Connectivity		•		•	•	•			•	•	•	•		•
Low Standby	•	•	•	•	•									•
Lockbox™ Security			•	•	•	•						•		•
System Integration (Flash, Mixed-Signal)		•	•	•	•	•					•			
600 MHz or Greater						•		•		•		•	•	•
Multicore													•	•

Automotive grade available.

Blackfin Processor Target Applications

ADSP-BF504/ADSP-BF504F/ADSP-BF506F: Optimized for industrial control and advanced power applications as well as low cost general-purpose DSP applications.

ADSP-BF512/ADSP-BF514/ADSP-BF516/ADSP-BF518: Low cost, low power, general-purpose parts with enhanced Internet and consumer connectivity.

ADSP-BF523/ADSP-BF525/ADSP-BF527 and ADSP-BF522/ADSP-BF524/ADSP-BF526: Low power processors that balance the combination of high performance, power efficiency, and system integration to enable highly optimized designs.

ADSP-BF531/ADSP-BF532: Low power, general-purpose processors for audio, voice, imaging, biometrics, and industrial applications.

ADSP-BF533: High performance for consumer video, security/surveillance, broadband home gateways, and automotive vision systems.

ADSP-BF534: CAN connectivity for automotive, industrial, and medical applications.

ADSP-BF535: Optimized for networked Internet applicances, central office/network switches, industrial control, and automation applications.

ADSP-BF536/ADSP-BF537: Embedded network connectivity for video, industrial, biometrics, instrumentation, medical, and consumer appliances.

ADSP-BF538/ADSP-BF538F: Ideally suited for a broad range of industrial, instrumentation, and medical appliance applications.

ADSP-BF542/ADSP-BF544/ADSP-BF547/ADSP-BF548/ADSP-BF549: High performance convergent multimedia processors with a flexible platform for industrial, instrumentation, consumer, communications, and automotive applications.

ADSP-BF561: Symmetric multiprocessor optimized for high performance signal and media processing.

Third-Party Developers

More than 200 third parties provide software, hardware, and consulting services to support Blackfin embedded processors. For more information, visit www.analog.com/processors/collaborative.

Hardware

- · Companion chip/chipsets
- · Development boards
- · Development systems
- Emulators
- · Evaluation/starter boards
- Reference designs
- COTS DSP boards
- · Daughter boards

Software and Algorithms

- Speech G.7xx
- Telephony (DTMF, caller ID, etc.)
- · Echo cancellation
- Audio (MP3, AAC/AAC+, WMA9, Dolby,® DTS,® etc.)
- Video/imaging (JPEG, MPEG-2/MPEG-4, H.264, H.263, WMV9, etc.)
- · Image processing
- · Facial/object recognition software
- VolP suites
- Embedded Web browser
- Voice recognition
- Proprietary algorithms (3D audio effects, etc.)

OS/RTOS

- · Green Hills® Software/INTEGRITY®
- Green Hills Software/velOSity™
- Green Hills Software/µ-velOSity™
- Express Logic/ThreadX[®]
- Micriμm μC/OS-II
- Quadros Systems/RTXC[™] Quadros
- Unicoi Systems™/Fusion™
- KADAK Systems/KwikNet™
- Open Source/µClinux
- Analog Devices VisualDSP++ Kernel

Design Test, Verification and Validation

- National Instruments
- The MathWorks

Software IDDE Tools

- Green Hills Software/MULTI®
- · GAIO TECHNOLOGY/Blackfin design kit

HW Development Kits

- PHYTEC/Rapid Development Kits
- Arcturus Networks

Design Services

- Boston Engineering
- · Schmid Engineering
- Advanced Energy Conversion

Complimentary Support Resources

EngineerZone

www.EZ.analog.com

Blackfin Visual Training and Development

www.analog.com/vld

Analog Devices Sales and Distributors

www.analog.com/salesdir

Processor and Development Tools Technical Support

www.analog.com/processors/technicalsupport

North America and Asia

processor.support@analog.com

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Follow Us On



http://www.twitter.com/blackfin



Network with our LinkedIn Group: Analog Devices Blackfin (www.linkedin.com)

Companion Power Selection Guide for the Blackfin Processor

a solution to meet your needs. it's a single processor or multiple processors, in handheld or high power application ADI power management products provide optimized power for Blackfin products-

How to Use This Guide

relevant data sheets and engineer-to-engineer notes. Then, use this companion select a power solution that offers the required V_{out} for that rail. Determine the peak current requirement for each rail of your processor by refer

for all of these solutions. Visit analog.com/ADIsimPower. The ADIsimPower™ design tool offers a complete set of features to create a con

Blackfin Processors ADSP-BF51x

Speed (MHz) ≧ ≦

Min Voltage (V) 18D

Max Voltage (V) 1.47 1.47

Max IDD_{INT} (mA) 225 250

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. . . .

20

N/A

N/A

3.0-18

3.15-14

ADP1829

ADP1864

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mplete BOM	rring to the n guide to		—whether .ions, ADI has	
I _{out} Max (A)	V _{out} (V)	V _{IN} (V)	Part Number	
150 mA	1.2-3.3	2.5–5.5	ADP121	
300 mA	0.8-3.0	1.6-3.6	ADP170	
2 outputs: 200 mA, 200 mA	0.8-2.8	2.5-5.5	ADP220	
1	0.75-3.3, soft start	2.5-5.5	ADP1706	_
1	0.75–3.3, with tracking	2.5-5.5	ADP1707	inear Regulators
500 mA	0.8-5.0	2.5-5.5	ADP1715	egulator
50 mA	1.225-5.0	4.0–28	ADP1720	S
2	0.75-3.0	1.6-3.6	ADP1740 ADP1741	
800 mA	0.75-2.5	1.6-3.6	ADP1752 ADP1753	
1.2	0.75–2.5	1.6-3.6	ADP1754 ADP1755	
600 mA	0.8–1.875	2.7-5.5	ADP2102	
1	1.2-3.3	2.7–5.5	ADP2105	
1.5	1.2-3.3	2.7–5.5	ADP2106	Swi
2	1.2-3.3	2.7–5.5	ADP2107	tching F
600 mA	1–3.3	2.3-5.5	ADP2108	Regulato
2/2, 1/3, or 4 single	0.8-3.3	2.7-5.5	ADP2114	ors
1	2.8-5.0	2.3-5.5	ADP2504	
3 outputs: 250 mA, 600 mA, 150 mA	N/A	2.4–5.5	ADP5020	

Many applications power more than one device or domain using a single regulator. Compute and add the maximum current draw for each device and domain

²Refer to the relevant data sheet and engineer-to-engineer note to determine the exact "other domain" requirements of each individual processor.

¹SC = switching controllers

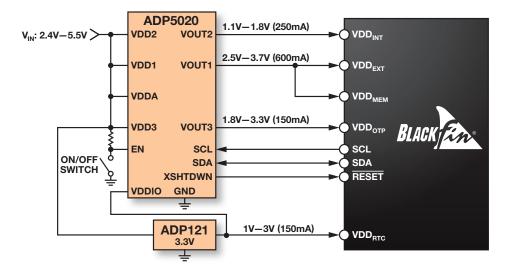
Other Domains²

VDD_{INT} Domain

The regulators marked in this guide support the current draw at the maximum specified frequency, voltage, and industrial temperature. Regulators not marked as compatible with a particular processor may still be appropriate depending on the frequency, voltage, temperature, and application code used. in a particular application before choosing a regulator.



Example* Power Solution for the Blackfin Processor



^{*}Numerous variables affect the power requirements of an embedded system. Ambient temperature, core and system frequency, supply voltages, pin capacitances, power modes, application code, and peripheral utilization all contribute to the average power requirements; therefore, this is just one suggested solution.

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